
Surface mounted light-emitting diode array comprises a flexible circuit board which is mounted on a longitudinal narrow side of a cooling element

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Patent Family

Patent Number	Kind	Date	Application Number	Kind	Date	Week	Type
DE 20120770	U1	20020328	DE U20120770	U	20011221	200240	B

Priority Applications (Number Kind Date): DE U20120770 U (20011221)

Patent Details

Patent	Kind	Language	Page	Main IPC	Filing Notes
DE 20120770	U1		19	H01L-033/00	

Abstract:

DE 20120770 U1

NOVELTY The surface mounted light-emitting diode (LED) array (10) comprises a flexible circuit board (14) with LEDs which is mounted on a longitudinal narrow side (19a) of a cooling element (16).

USE For external lighting, in particular, brake and warning lights of motor vehicles.

ADVANTAGE Heat removal from the LED array is improved.

DESCRIPTION OF DRAWING(S) The drawing shows an example of the proposed LED array.

LEDs (12)

Flexible circuit board (14)

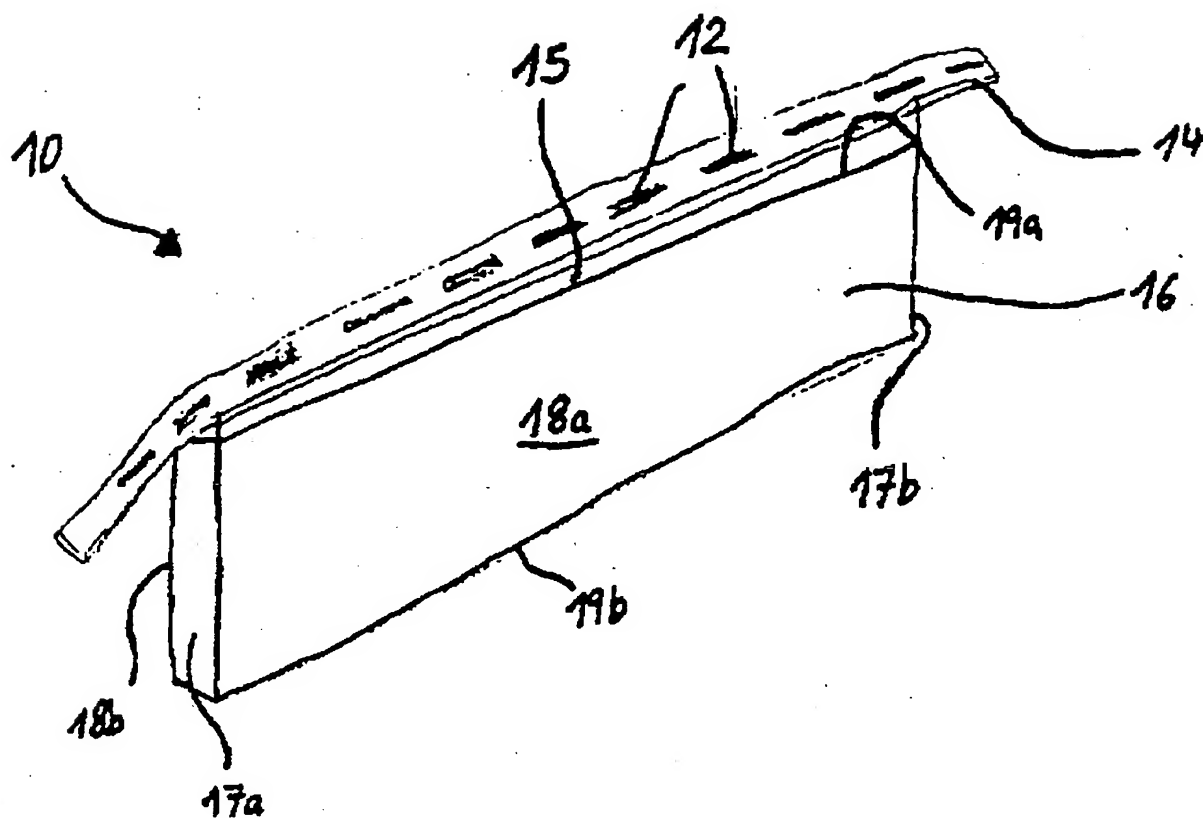
Intermediate layer (15)

Cooling element (16)

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Technology Focus:

TECHNOLOGY FOCUS - POLYMERS - The mounting arrangement of the LED array can include an intermediate layer of an electrically insulating epoxy resin with embedded particles of a material with good thermal conductivity. The materials for flexible circuit boards include polyester and polyimide foil.



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Dialog® File Number 351 Accession Number 14543410